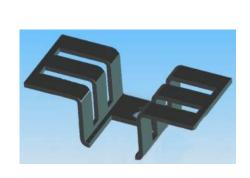
T0-220

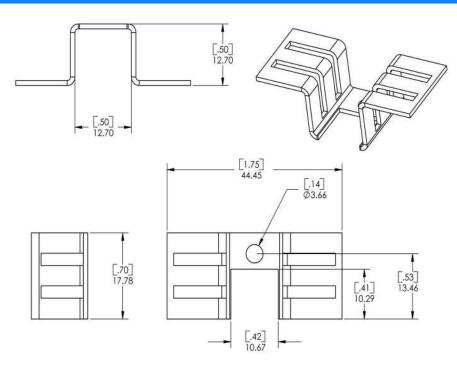
Board Level Heat Sinks



ThermaFlo

P/N: 822812B00000





PRODUCT SPECIFICATIONS —

• Devices: TO-220

Size: 17.8 x 44.5 x 12.7mmMaterial: Aluminum 1.0mm

· Type: Stamped

Finish: Black AnodizedMounting: Device Leads

· Package: Bulk

 Accessories: Hardware & Thermal Interface Material

Material

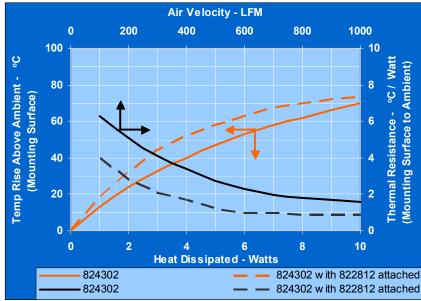
FEATURES & BENEFITS-

- · Hole for Device Attachment
- Mates with PN 824302B00000
- RoHS Compliant



CUSTOMIZED HEATSINKS

- Specialized Body Configurations
- · Contact Applications Engineering



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